

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ( $\pi$ -MOSVI)

# 2SK3767

## Switching Regulator Applications

- Low drain-source ON resistance:  $R_{DS(ON)} = 3.3\ \Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 1.6S$  (typ.)
- Low leakage current:  $I_{DSS} = 100\ \mu A$  ( $V_{DS} = 600\ V$ )
- Enhancement mode:  $V_{th} = 2.0$  to  $4.0\ V$  ( $V_{DS} = 10\ V$ ,  $I_D = 1\ mA$ )

## Maximum Ratings ( $T_a = 25^\circ C$ )

Characteristics	Symbol	Rating	Unit
Drain-source voltage	$V_{DSS}$	600	V
Drain-gate voltage ( $R_{GS} = 20\ k\Omega$ )	$V_{DGR}$	600	V
Gate-source voltage	$V_{GSS}$	$\pm 30$	V
Drain current	DC (Note 1)	$I_D$	A
	Pulse (Note 1)	$I_{DP}$	
Drain power dissipation ( $T_c = 25^\circ C$ )	$P_D$	25	W
Single pulse avalanche energy (Note 2)	$E_{AS}$	93	mJ
Avalanche current	$I_{AR}$	2	A
Repetitive avalanche energy (Note 3)	$E_{AR}$	4	mJ
Channel temperature	$T_{ch}$	150	$^\circ C$
Storage temperature range	$T_{stg}$	$-55 \sim 150$	$^\circ C$

## Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th(ch-c)}$	5.0	$^\circ C/W$
Thermal resistance, channel to ambient	$R_{th(ch-a)}$	62.5	$^\circ C/W$

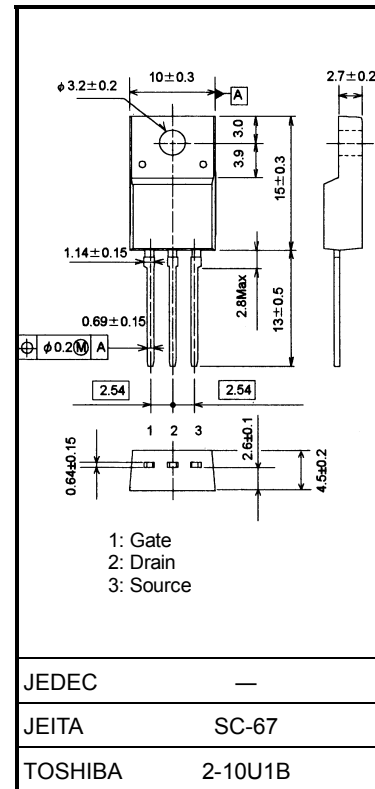
Note 1: Ensure that the channel temperature does not exceed  $150^\circ C$ .

Note 2:  $V_{DD} = 90\ V$ ,  $T_{ch} = 25^\circ C$  (initial),  $L = 41\ mH$ ,  $R_G = 25\ \Omega$ ,  $I_{AR} = 2\ A$

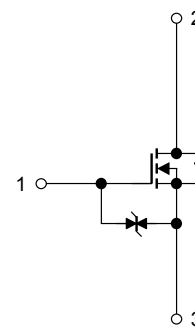
Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.

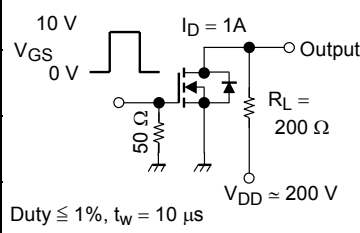
Unit: mm



Weight : 1.7 g (typ.)



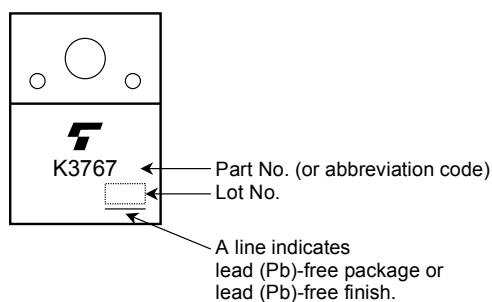
## Electrical Characteristics (Ta = 25°C)

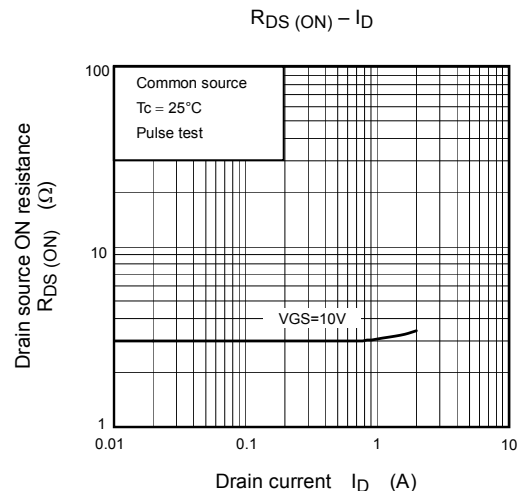
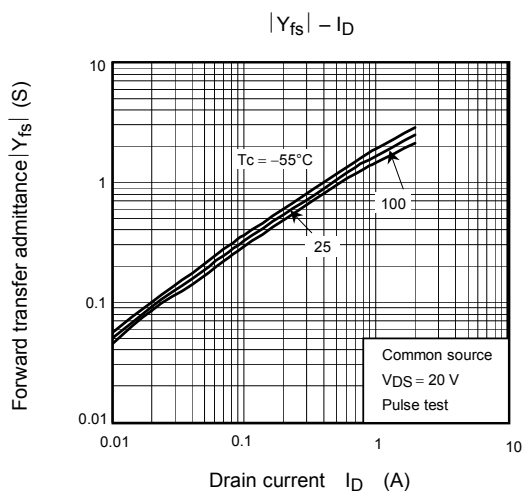
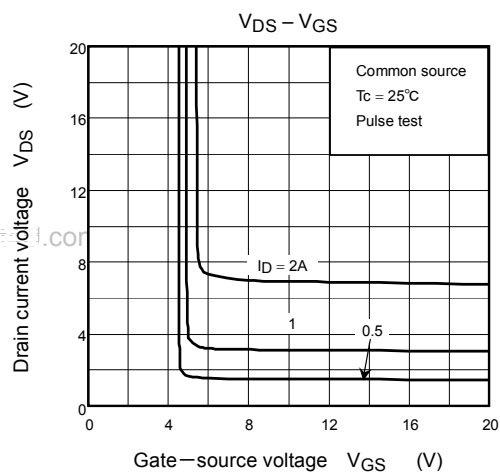
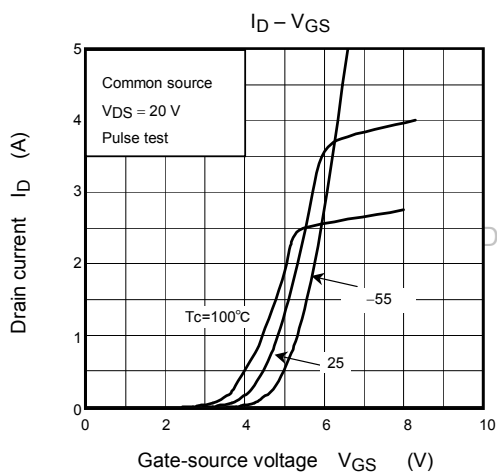
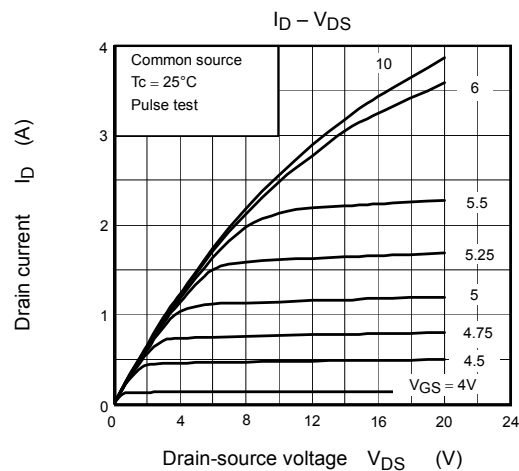
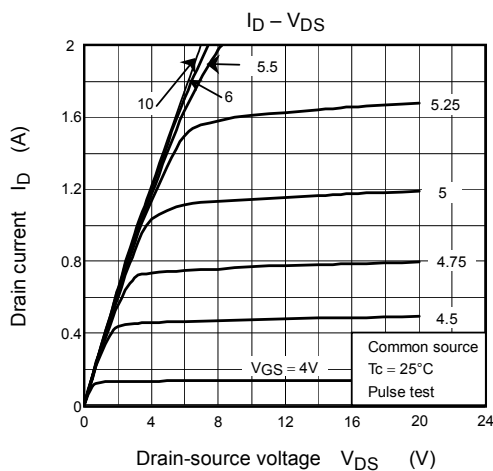
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 25\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Gate-source breakdown voltage		$V_{(BR)GSS}$	$I_G = \pm 10\text{ }\mu\text{A}, V_{DS} = 0\text{ V}$	$\pm 30$	—	—	V
Drain cut-off current		$I_{DSS}$	$V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$	—	—	100	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	600	—	—	V
Gate threshold voltage		$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	2.0	—	4.0	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = 10\text{ V}, I_D = 1\text{ A}$	—	3.3	4.5	$\Omega$
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 1\text{ A}$	0.8	1.6	—	S
Input capacitance		$C_{iss}$	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	320	—	pF
Reverse transfer capacitance		$C_{rss}$		—	30	—	
Output capacitance		$C_{oss}$		—	100	—	
Switching time	Rise time	$t_r$		—	15	—	ns
	Turn-on time	$t_{on}$		—	55	—	
	Fall time	$t_f$		—	20	—	
	Turn-off time	$t_{off}$		—	80	—	
Total gate charge		$Q_g$	$V_{DD} \approx 400\text{ V}, V_{GS} = 10\text{ V}, I_D = 2\text{ A}$	—	9	—	nC
Gate-source charge		$Q_{gs}$		—	5	—	
Gate-drain charge		$Q_{gd}$		—	4	—	

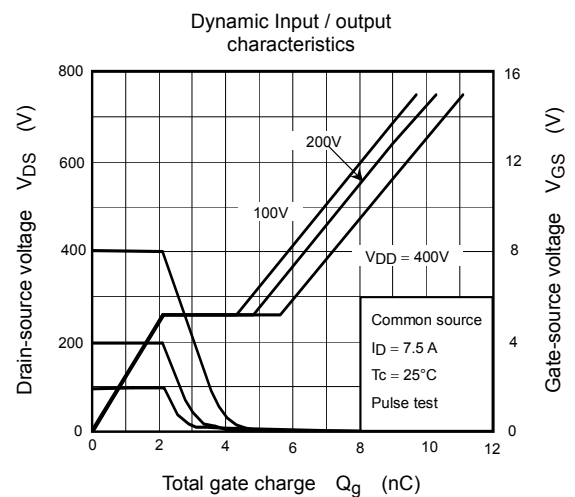
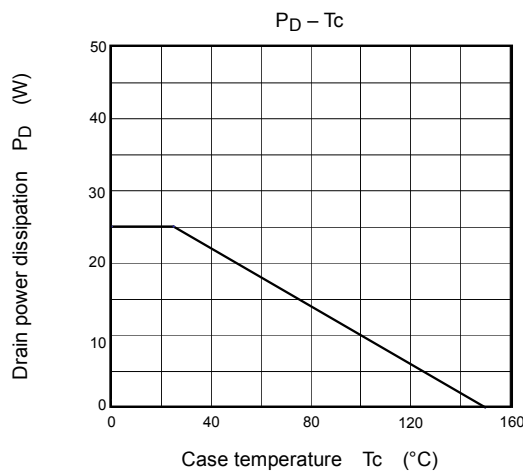
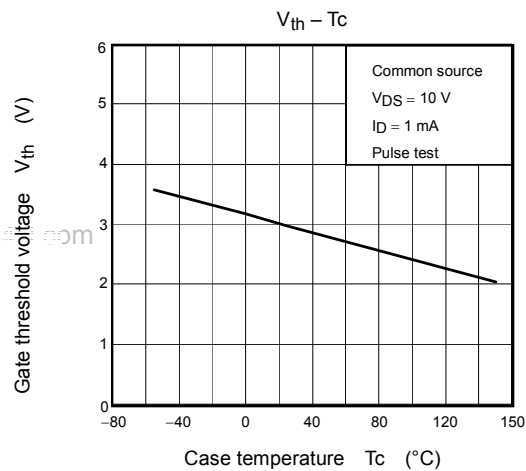
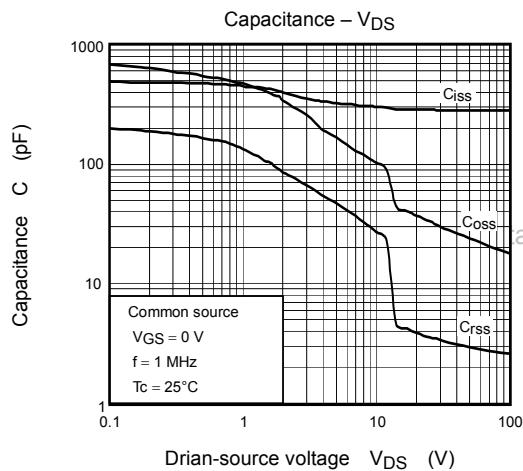
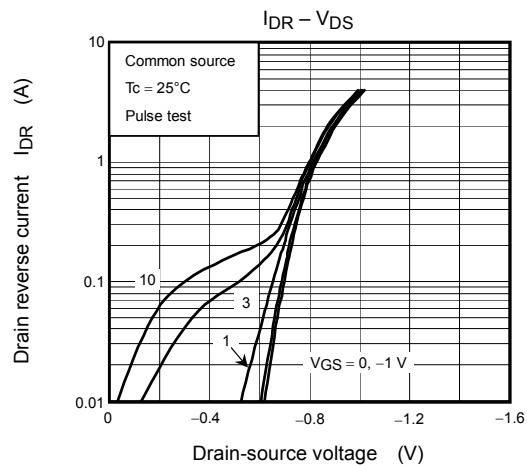
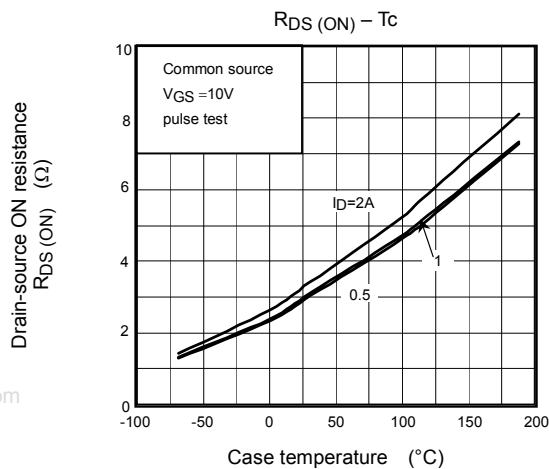
## Source-Drain Ratings and Characteristics (Ta = 25°C)

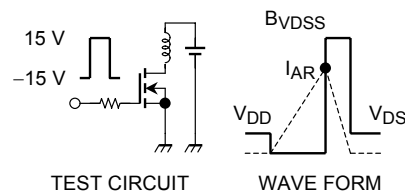
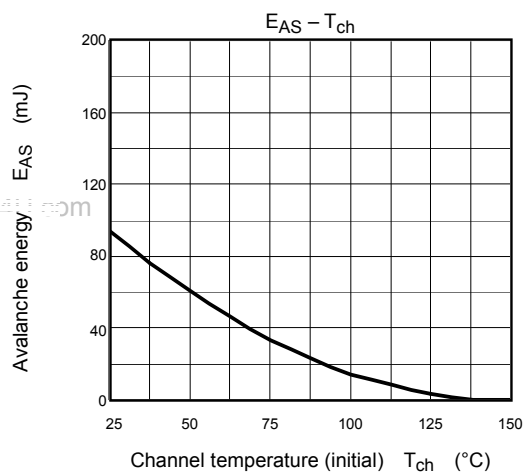
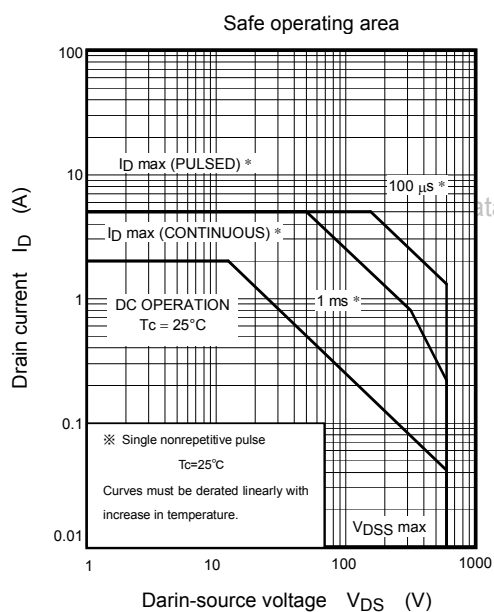
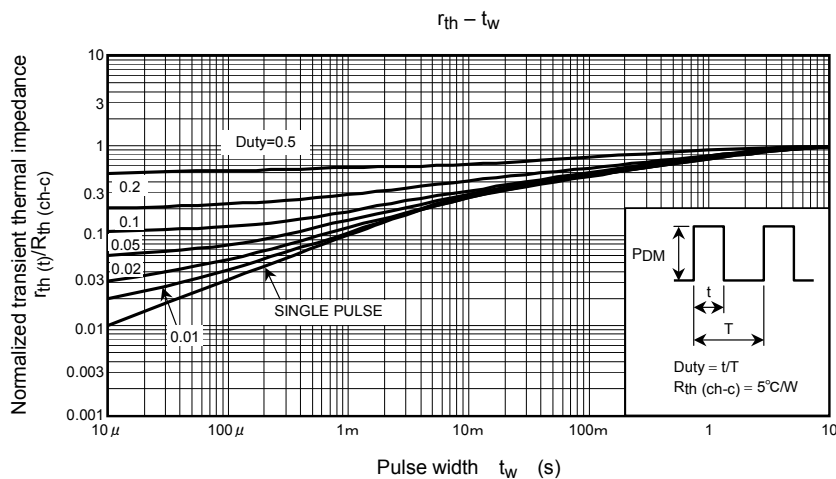
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	$I_{DR}$	—	—	—	2	A
Pulse drain reverse current (Note 1)	$I_{DRP}$	—	—	—	5	A
Forward voltage (diode)	$V_{DSF}$	$I_{DR} = 2\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.7	V
Reverse recovery time	$t_{rr}$	$I_{DR} = 2\text{ A}, V_{GS} = 0\text{ V},$	—	1000	—	ns
Reverse recovery charge	$Q_{rr}$	$dI_{DR}/dt = 100\text{ A}/\mu\text{s}$	—	3.5	—	$\mu\text{C}$

## Marking









$$R_G = 25 \, \Omega$$

$$V_{DD} = 90 \, V, L = 41 \, mH$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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